

1.0 SCOPE

1.1 CONTENT

This specification covers the requirements of the Molex L.F.H. Plug and Receptacle cable assemblies

1.2 REFERENCE SPECIFICATIONS

For applicable performance requirements refer to Molex specifications PS-70928

1.3 APPLICABLE SALES DRAWINGS:



2.0 PRODUCT DESCRIPTION

2.1 INSERT MOLDED STICK ASSEMBLY

See Sales Drawing# SDA-70984-100* - For 15 ckt sticks # SDA-71477-**** - For 20 ckt sticks



See Sales Drawing# SDA-70985-100*



<u>REVISION:</u>	ECR/ECN INFORMATION: EC No: UCP2005-2088 DATE: 2005 / 03 / 18	TITLE:APPLICATION SPECIFICATION60 AND 80 CKT LFHCABLE ASSEMBLY		TION	<u>SHEET No.</u> 1 of 20
DOCUMENT NUMBER:		CREATED / REVISED BY:	CHECKED BY:	APPROVED BY:	
AS-70929-001		MIBARRA	BSMART	SMILLER	

TEMPLATE FILENAME: APPLICATION_SPEC[SIZE_A](V.1).DOC



2.0 PRODUCT DESCRIPTION (CONT'D) 2.3 EMI SHIELD AND FERRULE FOR OVERMOLDING

EMI Shield Kit

Refer to Molex Drawing # SDMS-71245-2000 - 60 ckt SDMS-71245-3000 - 60 ckt SDMS-71723-000* - 80 ckt

2.4 METAL BACKSHELL SUB-ASSEMBLY FOR 60 CKT ONLY, NOT SUPPLIED BY MOLEX. Standard 15-pin D-sub backshell fits the 60 ckt LFH (Contact Factory for suggested sources.)

3.0 REQUIREMENTS

3.1 WIRE

Wire shall be specified as follows:

CONDUCTOR	INSULATION DIA.
28 AWG STRANDED	021"+ 0015"
.0126" DIA.	.031 ±.0015
30 AWG STRANDED	024" 0045"
.0100" DIA.	.024 ±.0015

NOTE: Contact Molex for application of other wires

4.0 SUGGESTED APPLICATION TOOLING DEVELOPED BY MOLEX 4.1 STICK PREPERATION UNIT FOR 60 AND 80 CKT

Manual Press for Stick Preparation Order number for tooling only: 62200-1100 Order number for basic press: 11-31-6356

For further information, contact factory representative

REVISION:	ECR/ECN INFORMATION:				SHEET No.
Δ	EC No: UCP2005-2088	60	60 AND 80 CKT LFH		4 of 20
~	DATE: 2005 / 03 / 18	CABLE ASSEMBLY			
DOCUMENT NUMBER:		CREATED / REVISED BY:	CHECKED BY:	APPROVED BY:	
AS-70929-001		MIBARRA	BSMART	SMILLER	
TEMPLATE FILENAME: APPLICATION_SPEC[SIZE_A](V.1).DOC					

<u>NOTE</u>: Surface appearance is not always a good indicator of weld quality. Insufficient heating or inadequate penetrations, for example, usually leave no visible effects on the work piece.

6.5 CRACKS, SPITTING (FORCIBLE EJECTION OF MATERIAL FROM THE WELD), AND VOIDS ARE NOT PERMITTED.

6.6 SPIKES ON THE TOP SURFACE OF THE WIRE (EVIDENCE OF "TIP PICKUP" OR WELDING OF THE ELECTRODE) ARE CAUSE FOR REJECTION.

6.7 PEEL TEST

The peel strength of each conductor bundle must be greater then 75% of the tensile strength of the undisturbed bundle.

$$A_p = (3 \times S_d) \ge 0.75 \times T_w$$

Where:

 A_p = the average peel test value

 S_d = the standard deviation of these values

 T_w = the tensile strength of the wire

i.e. The mean tensile strength of the samples must be at least 3 standard deviations greater then 75% of the wire's original tensile strength.

REVISION:	ECR/ECN INFORMATION:			SHEET No.	
Δ	EC No: UCP2005-2088	60 AND 80 CKT LFH		7 of 20	
~	DATE: 2005 / 03 / 18	CABLE ASSEMBLY			
DOCUMENT NUMBER:		CREATED / REVISED BY: CHECKED BY: APP		<u>APPRO</u>	/ED BY:
AS-70929-001		MIBARRA BSMART SM		SMIL	LER
TEMPLATE FILENAME: APPLICATION_SPEC[SIZE_A](V.1).DOC					

Fully	y latched	ctional View of Assembles	d Connectors	Fully latch	ed
REVISION:	ECR/ECN INFORMATION:		TION SPECIFICA	TION	SHEET No.
Δ	EC No: UCP2005-2088	60	AND 80 CKT LFH		10 of 20
~	<u>DATE:</u> 2005 / 03 / 18	CA	BLE ASSEMBLY		
DOCUMENT NUMBER:		CREATED / REVISED BY:	CHECKED BY:	APPROV	ED BY:
AS-70929-001		MIBARRA	BSMART	SMIL	LER
TEMPLATE FILENAME: APPLICATION_SPEC[SIZE_A](V.1).DOC					

8.0 COMPLETE ASSEMBLY (CONT'D)

RECEPTACLE:

9.0 INSPECTION: PLUG

10.0 INSPECTION : RECEPTACLE 10.1 MOLDED STICK VISUAL CHECKS

THE MATING END (GOLD) OF THE STICKS MUST NOT BE DAMAGED IN ANY WAY DURING TRIMING, TERMINATION AND ASSEMBLY PROCESSES

Examples of Unacceptable Conditions

10.0 INSPECTION: RECEPTACLE (CONT'D) 10.3 POSITION REQUIREMENTS (CONNECTOR CONTACTS) [CONT'D]

*CONTACT BEAM 1 MAY BE LOCATED ANYWHERE WITHIN THE BOUNDARIES OF POSITION ZONE (\widehat{A}) PROVIDED THAT THE CONDITIONS OF DETAIL "B" ARE MET.

*CONTACT BEAM 2 MAY BE LOCATED ANYWHERE WITHIN THE BOUNDARIES OF POSITION ZONE (B) PROVIDED THAT THE CONDITIONS OF DETAIL "B" ARE MET.

NOTE: ALL POSITION MEASUREMENTS TO BE TAKEN AT CONTACT POINTS, NOT AT CONTACT TIPS. ALL POSITION ZONES ARE TO BE DEFINED RELATIVE TO THE HOUSING CORE CENTERLINES.

10.4 LATCH REQUIREMENTS

